#### **GENERAL DESCRIPTION**

The CM2593/P is a monolithic integrated circuit that provide all the active functions for a step-down switching regulator, capable of driving a 2A load without additional transistor component. Requiring a minimum number of external component, the board space can be saved easily. The external shutdown function can be controlled by TTL logic level and then come into standby mode. The internal compensation makes feedback control have good line and load regulation without external design. Regarding protected function, thermal shutdown is to prevent over temperature operating from damage, and current limit is against over current operating of the output switch. The CM2593/P operates at a switching frequency of 150Khz thus allowing smaller sized filter components than what would be needed with lower frequency switching regulators. Other features include a guaranteed +4% tolerance on output voltage under specified input voltage and output load conditions, and +15% on the oscillator frequency. The output version included fixed 3.3V, 5V, and an adjustable type. The packages are available in a standard 8-lead SOP8.

#### **FEATURES**

- ◆ 3.3V, 5V and adjustable output versions
- Adjustable version output voltage range, 1.23V to 37V ±4% max over line and load condition
- ◆ SOP-8L packages
- ♦ Voltage mode non-synchronous PWM control
- ◆ Thermal-shutdown and current-limit protection
- ♦ ON/OFF shutdown control input
- Input voltage range up to 40V
- Output load current: 2A
- 150 kHz fixed frequency internal oscillator
- Low power standby mode
- Built-in switching transistor on chip

#### **APPLICATIONS**

- ◆ Simple High-efficiency step-down(buck) regulator
- ◆ Efficient pre-regulator for linear regulators
- On-card switching regulators
- Battery / Car Charger
- Positive to negative converter
- Digital Still and Video Cameras

#### TYPICAL APPLICATIONS

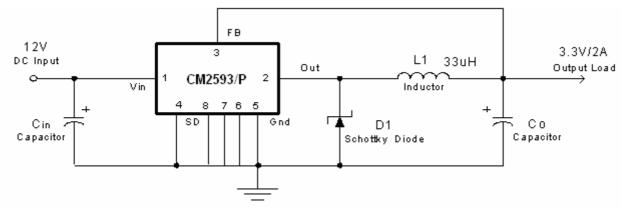
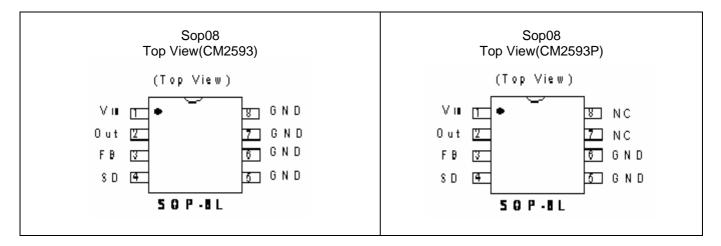


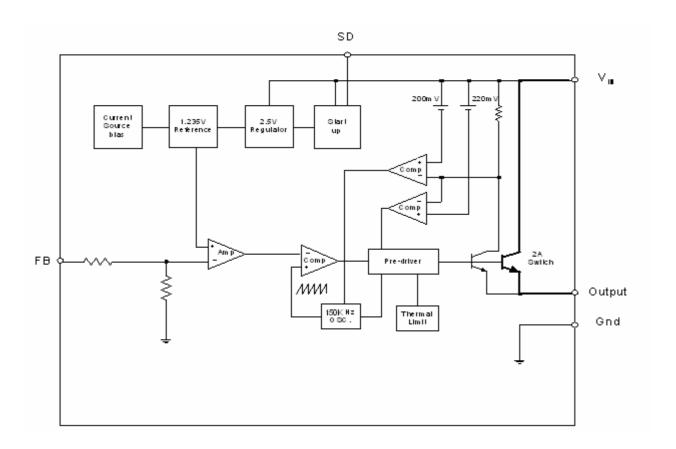
Figure 1. Basic Application Circuit with CM2593/P fixed version



## **PIN CONFIGURATION**



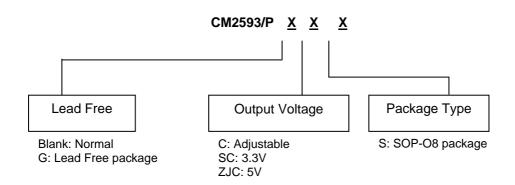
## **BLOCK DIAGRAM**



#### PIN DESCRIPTION

Pin No.	Symbol	Description			
1	V <sub>IN</sub>	Operating voltage input			
2	Out	Switching output			
3	FB	Output voltage feedback control			
4	SD	ON/OFF Shutdown			
5-8	GND	Ground Pin			

## **ORDERING INFORMATION**



#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Rating	Unit
V <sub>CC</sub>	Supply Voltage	+45	V
V <sub>SD</sub>	ON/OFF Pin input voltage	-0.3 to +25	V
$V_{FB}$	Feedback Pin voltage	-0.3 to +25	V
V <sub>OUT</sub>	Output voltage to Ground	-1	V
P <sub>D</sub>	Power dissipation	Internally limited	W
T <sub>ST</sub>	Storage temperature	-65 to +150	°C
T <sub>OP</sub>	Operating temperature	-40 to +125	°C
V <sub>OP</sub>	Operating voltage	+4.5 to +45	V
heta Ja	heta Ja Thermal Resistance		°/W
$ heta_{ m Jc}$ Thermal Resistance		14	°/W



## ■ **ELECTRICAL CHARACTERISTICS**(All Output Voltage Versions)

Unless otherwise specified,  $V_{IN}$ =12V for 3.3V, 5V, adjustable version and  $V_{IN}$ =24V for the 12V version.  $I_{LOAD}$  = 0.2A

Symbol	Parameter		Conditions	Min.	Тур.	Max.	Unit	
	Feedback bias current		V <sub>FB</sub> =1.3V		-10	-50	nΛ	
l <sub>B</sub>			(Adjustable version only)		-10	-100	nA	
L			T <sub>J</sub> =25°C	127	150	173	Kh-	
Fosc	oscillator fre	quency	-40°C<=TJ<=125°C	110	150	173	Khz	
Fscp	Oscillator fre		When current limit occurred and VFB <0.55V		30	60	Khz	
			I <sub>OUT</sub> =1.5A			1.4		
$V_{SAT}$	saturation vo	oltage	no outside circuit		1.15	1.5	V	
			V <sub>FB</sub> =0V force driver on			1.5		
DC	Max. Duty Cycle(ON)		V <sub>FB</sub> =0V force driver on		100		%	
ЪС	Min. Duty cy	cle(OFF)	V <sub>FB</sub> =12V force driver off		0		70	
	current limit		peak current			3.3		
$I_{CL}$			no outside circuit	2.4	2.8	3.6	Α	
			V <sub>FB</sub> =0 force driver on			3.0		
	Outrat 0		no outside circuit			-200	uA	
IL	Output = 0	Output leakage current	V <sub>FB</sub> =12 force driver off		<u> </u>	-200	uA	
	Output = 1		V <sub>IN</sub> =24V		-5		mA	
IQ	Quiescent C	urrent	V <sub>FB</sub> =12 force driver off		5	10	mA	
1	Standby Quiescent		ON/OFF pin=5V		70	150		
I <sub>STBY</sub>	Current		V <sub>IN</sub> =24V		70	200	uA	
V <sub>IL</sub>			Low (regulator ON)	-		0.6		
$V_{IH}$	ON/OFF pin logic input threshold voltage		High (regulator OFF)	2.0	1.3	-	V	
I <sub>H</sub>	ON/OFF pin logic input current		V <sub>LOGIC</sub> =2.5V (OFF)			-0.01	uA	
ار	ON/OFF pin input current		V <sub>LOGIC</sub> =0.5V (ON)		-0.1	-1		
Ts	Over temperature shutdown threshold		Tj increasing		175	175		
15			Tj decreasing		150		°C	



	Symbol	Parameter	Conditions	Тур.	Limit	Unit
CM2593/P-ADJ	$V_{FB}$	Output Feedback	$5V \le V_{\text{IN}} \le 40V$ $0.2A \le I_{\text{LOAD}} \le 2A$ $V_{\text{OUT}} \text{ programmed for } 3V$	1.235	1.193/1.18 1.267/1.28	V V <sub>MIN</sub> V <sub>MAX</sub>
	η	Efficiency	$V_{IN} = 12V$ , $I_{LOAD} = 2A$	75		%
CM2593/P-3.3V	V <sub>OUT</sub>	Output voltage	$5.5V \le V_{IN} \le 40V$ $0.2A \le I_{LOAD} \le 2A$	3.3	3.168/3.135 3.432/3.465	V V <sub>MIN</sub> V <sub>MAX</sub>
	η	Efficiency	V <sub>IN</sub> = 12V, I <sub>LOAD</sub> =2A	75		%
CM2593/P-5V	V <sub>OUT</sub>	Output voltage	$8V \le V_{IN} \le 40V$ $0.2A \le I_{LOAD} \le 2A$	5	4.8/4.75 5.2/5.25	V V <sub>MIN</sub> V <sub>MAX</sub>
	η	Efficiency	V <sub>IN</sub> = 12V, I <sub>LOAD</sub> =2A	80		%

Specifications with boldface type are for full operating temperature range, the other type are for T<sub>J</sub>=25°C.



#### **FUNCTIONAL DESCRIPTION**

#### **Pin Functions**

#### $+V_{IN}$

This is the positive input supply for the IC switching regulator. A suitable input bypass capacitor must be present at this pin to minimize voltage transients and to supply the switching currents needed by the regulator.

#### Out

Internal switch and power output. The voltage at this pin switches between ( $+V_{IN}-V_{SAT}$ ) and approximately - 0.5V, with a duty cycle of approximately  $V_{OUT}/V_{IN}$ . The PC board copper area connected to this pin should be kept a minimum in order to reduce the coupling sensitivity to the circuitry

#### Ground

Circuit ground.

#### **Feedback**

Complete the feedback loop by sensing the regulated output voltage

#### ON/OFF

Allows the switching regulator circuit to be shutdown using logic level signals thus dropping the total input supply current to approximately 100uA. Pulling this pin below a threshold voltage of approximately 1.3V turns the regulator on, and pulling this pin above 1.3V (up to a maximum of 25V) shuts the regulator down. If this shutdown feature is not needed, the  $\overline{ON}/OFF$  pin can be wired to the ground pin or it can be left open, in either case the regulator will be in the ON condition.

#### **Thermal Considerations**

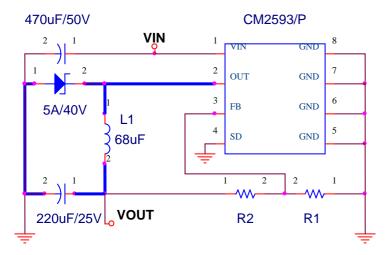
The SOP-8 package needs a heat sink under most conditions. The size of the heat-sink depends on the input voltage, the output voltage, the load current and the The CM2593/P ambient temperature. iunction temperature rises above ambient temperature for a 2A load and different input and output voltages. The data for these curves was taken with the CM2593/P (SOP-8 package) operating as a buck switching regulator in an ambient temperature of 25°C (still air). These temperature increments are all approximate and are affected by many factors. Some of these factors include board size, shape ,thickness ,position ,location, and even board temperature. Other factors are trace width, total printed circuit copper area, copper thickness, single or double-sided, multi-layer board and amount of solder on the board. Higher ambient temperatures require more heat sinking.

For the best thermal performance ,wide copper traces and generous amounts of printed circuit board copper should be used in the board layout. (One exception is the out(switch) pin, which should not have large areas of copper.) Large areas of copper provide the best transfer of heat(lower thermal resistance) to the surrounding air, and moving air lowers the thermal resistance even further.

The effectiveness of the PC board to dissipate heat also depends on the size, quantity and spacing of other components on the board, as well as whether the surrounding air is still or moving. Furthermore, some of these components such as the catch diode will add heat to the PC board and heat can vary as the input voltage changes. For the inductor, depending on the physical size, type of core material and the DC resistance, it could either act as a heat sink taking heat away from the board, or it could add heat to the board.



#### **APPLICATIONS CIRCUIT**

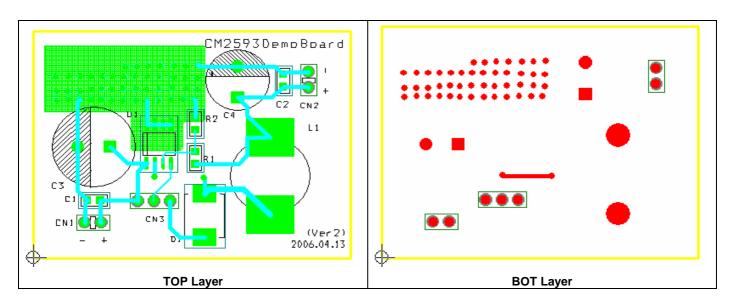


Output Voltage Fixed: R1=NC , R2=0

Output Voltage Adj : Vo=Vref\*(1+(R2/R1))

Vfb = 1.235V ;  $R1=1K\sim 5K$ 

### **APPLICATIONS Demo Board Layout**

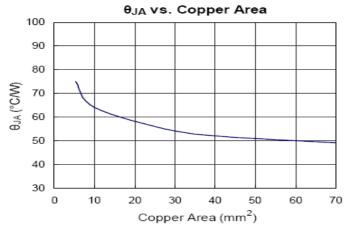


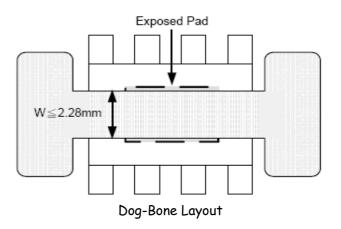
#### Notice:

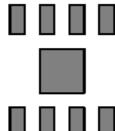
- 1. R1/R2 must be close to Pin3 (VFB), but keep feedback wiring away from inductor.
- 2. Inductor/diode must be close to Pin2 (Vout ), heavy lines must be keep short and thick .
- 3. Please to refer to Circuit and Demo Board Layout (the Fig. as above)

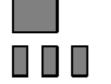
#### **DIFFERENT HEATSINK AREA**

#### Thermal Resistance vs. Different Cooper Area Layout Design

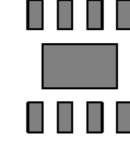


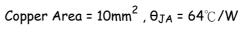


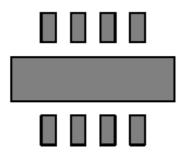




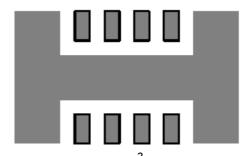
Minimum Footprint ,  $\theta_{JA} = 75^{\circ}$ C/W



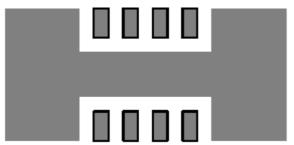




Copper Area =  $30\text{mm}^2$  ,  $\theta_{JA}$  =  $54^\circ\text{C/W}$ 



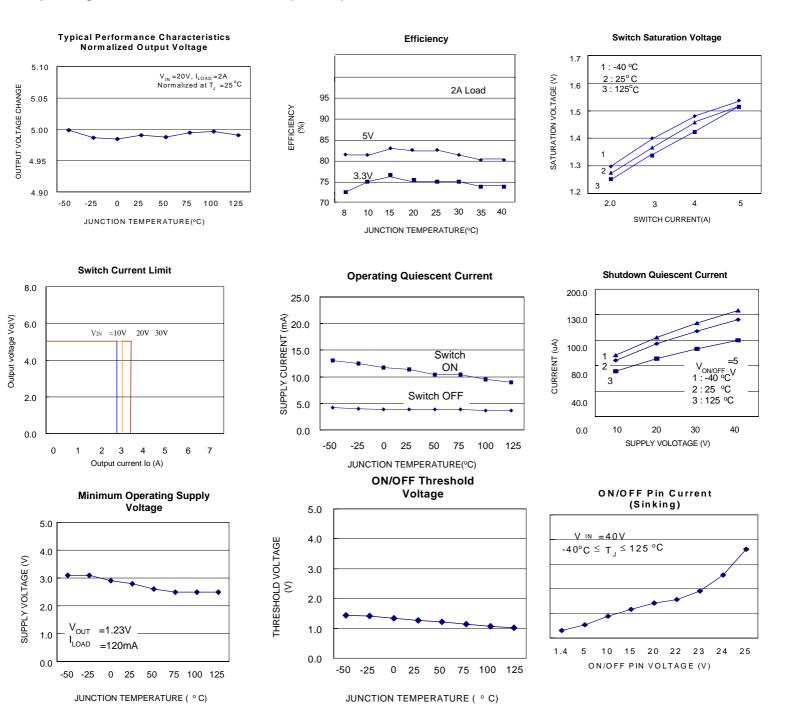
Copper Area =  $50\text{mm}^2$  ,  $\theta_{\text{JA}}$  =  $51^{\circ}\text{C/W}$ 



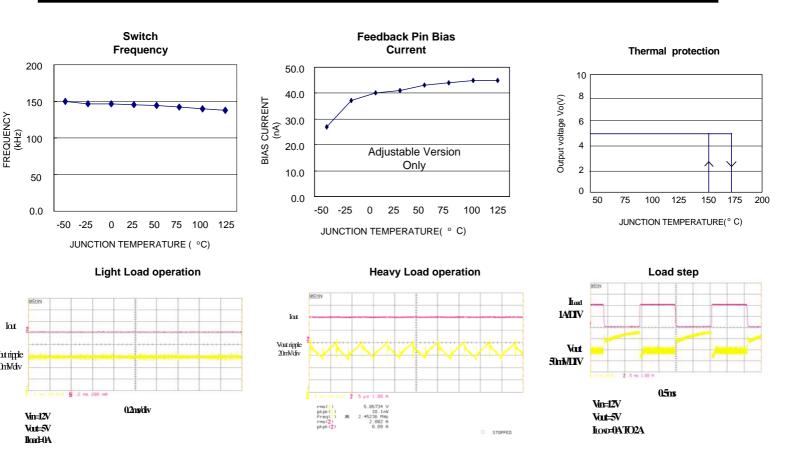
Copper Area =  $70\text{mm}^2$  ,  $\theta_{JA}$  =  $49^\circ\text{C}/\text{W}$ 

## **Typical Performance Characteristics**

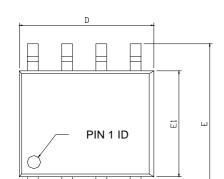
(Test Figure 1 above unless otherwise specified)



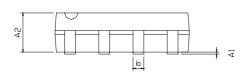


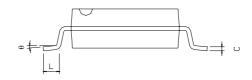


## **PACKAGE DIMENSION**



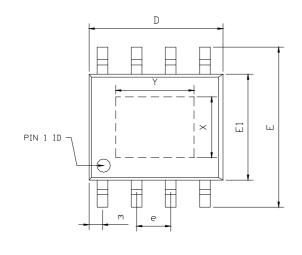
SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHS		
SIMBOLS	MIN	NOM	MAX	MIN	NOM	MAX
A1	0.10		0.25	0.004		0.010
A2	1.40		1.55	0.055		0.061
р	0.30		0.51	0.012		0.020
ď	0.15	-	0.26	0.006		0.010
D	4.60		5.06	0.169		0.199
E	5.79		6.20	0.228		0.244
E1	3.76		4.01	0.148		0.158
e		1.27			0.050	
L	0.38		0.69	0.015		0.035
m	0.43		0.69	0.017		0.027
θ	0°		8°	0°		8°





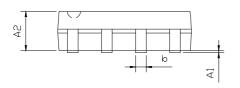
#### 8-Pin SOP w/ Power Pad (PS08)

8-PIN SOP (S08)



SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHS		
	MIN	NOM	MAX	MIN	NOM	MAX
A1	0.10		0.25	0.004		0.010
A2	1.40		1.55	0.055		0.061
b	0.30		0.51	0.012		0.020
C	0.15	-	0.26	0.006	-	0.010
D	4.60		5.06	0.169		0.199
E	5.79	-	6.20	0.228		0.244
E1	3.76		4.01	0.148		0.158
e		1.27			0.050	
L	0.38	-	0.69	0.015	-	0.035
m	0.43		0.69	0.017		0.027
θ	0°		8°	0°		8°

EXPOSED PAD DIMENSION : (mm) PAD SIZE: X=2.34 ; Y=2.92







#### **IMPORTNT NOTICE**

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#### HsinChu Headquarter

5F, No. 11, Park Avenue II, Science-Based Industrial Park, HsinChu City, Taiwan 300

TEL: +886-3-567 9979 FAX: +886-3-567 9909

http://www.champion-micro.com

#### Sales & Marketing

7F-6, No.32, Sec. 1, Chenggong Rd., Nangang District, Taipei City 115, Taiwan R.O.C.

TEL: +886-2-2788 0558 FAX: +886-2-2788 2985